TOSHIBA CMOS DIGITAL INTEGRATED CIRCUIT SILICON MONOLITHIC

## TC7WT241FU

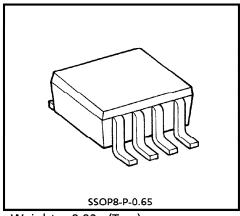
## **NON-INVERTED, 3-STATE OUTPUT**

The TC7WT241FU is a high speed CMOS DUAL BUS BUFFERS fabricated with silicon gate CMOS technology. It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The input threshold levels are compatible with TTL output voltage.

It is an non-inverting 3-state buffer has one active-high and one active-low output enable.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

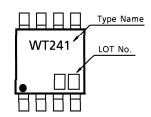


Weight: 0.02g (Typ.)

#### **FEATURES**

- High Speed ...... t<sub>pd</sub> = 13ns (Typ.) at V<sub>CC</sub> = 5V
- Low Power Dissipation  $\cdots I_{CC} = 2\mu A$  (Max.) at  $Ta = 25^{\circ}C$
- Compatible with TTL outputs ····· V<sub>IL</sub> = 0.8V (Max.), V<sub>IH</sub> = 2.0V (Min.)
- Output Drive Capability ...... 15 LSTTL Loads
- Symmetrical Output Impedance ··· |IOH| = IOL = 6mA (Min.)

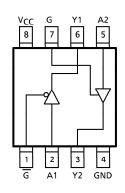
#### **MARKING**



#### **MAXIMUM RATINGS** (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Supply Voltage Range	Vcc	-0.5~7	V
DC Input Voltage	VIN	-0.5~V <sub>CC</sub> +0.5	٧
DC Output Voltage	Vout	-0.5~V <sub>CC</sub> + 0.5	V
Input Diode Current	ΙΚ	± 20	mA
Output Diode Current	loк	± 20	mA
DC Output Current	lout	± 35	mΑ
DC V <sub>CC</sub> /Ground Current	lcc	± 37.5	mA
Power Dissipation	PD	300	mW
Storage Temperature	T <sub>stg</sub>	<b>-65∼150</b>	°C
Lead Temperature (10 s)	TL	260	°C

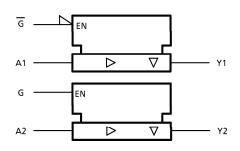
PIN ASSIGNMENT (TOP VIEW)



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### **LOGIC DIAGRAM**



### TRUTH TABLE

		INPUTS	OUTPUTS			
1	G	G	Α	Υ		
	L	Н	L	L		
	L	Н	Н	Н		
	Н	L	×	Z		

x : Don't Care Z : High Impedance

### **RECOMMENDED OPERATING CONDITIONS**

CHARACTERISTIC	SYMBOL	RATING	UNIT
Supply Voltage	Vcc	4.5~5.5	V
Input Voltage	VIN	0∼V <sub>CC</sub>	V
Output Voltage	Vout	0∼V <sub>CC</sub>	V
Operating Temperature	T <sub>opr</sub>	<b>- 40∼85</b>	°C
Input Rise and Fall Time	t <sub>r</sub> , t <sub>f</sub>	0~500	ns

#### DC ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	SYMBOL TEST C		ONDITION	Vcc	Ta = 25°C		Ta = -40~85°C		UNIT	
CHARACTERISTIC	3 I WIBOL	DL TEST CONDITION		Vсс (V)	MIN.	TYP.	MAX.	MIN.	MAX.	UNII
High-Level	\/			4.5~	2.0			2.0		V
Input Voltage	VIH			5.5	2.0	_	_	2.0	_	·
Low-Level	1/			4.5~			0.0		0.0	V
Input Voltage	VIL			5.5			0.8	_	0.8	·
High-Level	\/ <b>.</b>	VIN = VIL	$I_{OH} = -20\mu A$	4.5	4.4	4.5	_	4.4	_	V
Output Voltage	VOH	or V <sub>IL</sub>	I <sub>OH</sub> = -6mA	4.5	4.18	4.31	_	4.13	_	V
Low-Level	\/ a :	$V_{IN} = V_{IH}$	$I_{OL} = 20 \mu A$	4.5	_	0.0	0.10	_	0.10	V
Output Voltage	VOL	or V <sub>IL</sub>	I <sub>OL</sub> = 6mA	4.5	_	0.17	0.26	_	0.33	V
3-State Output	la-	V <sub>IN</sub> = = V <sub>IH</sub> or V <sub>IL</sub> V <sub>OUT</sub> = V <sub>CC</sub> or GND		5.5	5.5 —	_	±0.5	_	± 5.0	μΑ
Off-State Current	loz									
Input Leakage	1	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5			± 0.1		± 1.0	
Current	IN			3.5	-	-	_ ± 0.1		- 1.0	$\mu$ A
	Icc	V <sub>IN</sub> = V <sub>CC</sub> or GND		5.5	_	_	2.0	_	20.0	μΑ
Quiescent Supply		PER INPUT	: V <sub>IN</sub> = 0.5V							
Current	<sup>I</sup> CCT		or 2.4V	5.5	<b>—</b>	<b> </b>	2.0	_	2.9	mΑ
		OTHER INPUT: V <sub>CC</sub> or GND								

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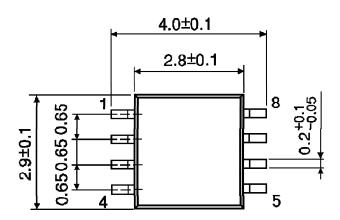
### AC ELECTRICAL CHARACTERISTICS (Input $t_r = t_f = 6ns$ )

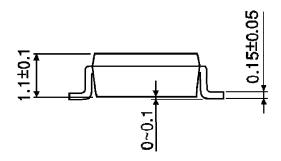
CHARACTERISTIC	SYMBOL	TEST CONDITION		Ta = 25°C			Ta = -40~85°C		UNIT	
CHARACTERISTIC	STIVIBUL		CL	Vcc	MIN.	TYP.	MAX.	MIN.	MAX.	UNIT
Output Transition	<sup>t</sup> TLH		50	4.5	_	7	12	-	15	ns
Time	tTHL	_	50	5.5	_	6	11	_	14	115
		_		4.5	_	15	25	_	31	ns
Propagation Delay	t <sub>pLH</sub>		50	5.5	_	13	22	_	28	
Time	tpHL		150	4.5	_	21	33	_	41	
	'			5.5	_	18	29	_	37	
	<sup>t</sup> pZL <sup>t</sup> pZH	$R_L = 1k\Omega$	50 150	4.5	_	17	30	_	38	ns
Output Enghia Tima				5.5	_	14	27	_	34	
Output Enable Time				4.5	_	23	38	_	48	
				5.5	_	20	34	_	43	
Output Disable Time	<sup>t</sup> pLZ <sup>t</sup> pHZ	$R_L = 1k\Omega$	50	4.5	_	16	30	_	38	
				5.5	_	13	27	_	34	ns
Input Capacitance	CIN	_	_	_	_	5	10	_	10	рF
Output Capacitance	COUT		_		_	10	<u> </u>			рF
Power Dissipation Capacitance	C <sub>PD</sub>	(Note 1)	_	_	_	32	_	_	_	pF

(Note 1): CpD is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation:  $|CC(opr)| = CpD \cdot VCC \cdot f|N + |CC|/2$  (per Gate)

# OUTLINE DRAWING SSOP8-P-0.65

Unit: mm





Weight: 0.02g (Typ.)